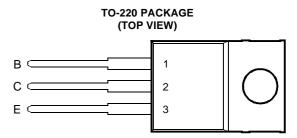
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- Designed for Complementary Use with BDW73, BDW73A, BDW73B, BDW73C and BDW73D
- 80 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 3 A



Pin 2 is in electrical contact with the mounting base.

MDTRACA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT	
	BDW74		-45	
	BDW74A		-60	
Collector-base voltage ($I_E = 0$)	BDW74B	V _{CBO}	-80	V
	BDW74C		-100	
	BDW74D	-	-120	
	BDW74	-	-45	
Collector-emitter voltage (I _B = 0) (see Note 1)	BDW74A	2	-60	
	BDW74B	V _{CEO}	-80	V
	BDW74C		-100	
	BDW74D		-120	
Emitter-base voltage	-	V _{EBO}	-5	V
Continuous collector current		Ι _C	-8	A
Continuous base current		I _B	-0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)			80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)			2	W
Unclamped inductive load energy (see Note 4)		½Ll _C ²	75	mJ
Operating junction temperature range			-65 to +150	°C
Operating temperature range			-65 to +150	°C
Operating free-air temperature range			-65 to +150	°C

NOTES: 1. These values apply when the base-emitter diode is open circuited.

2. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: L = 20 mH, $I_{B(on)}$ = -5 mA, R_{BE} = 100 Ω , $V_{BE(off)}$ = 0, R_S = 0.1 Ω , V_{CC} = -20 V.

PRODUCT INFORMATION

Information is current as of publication date. Products conform to specifications in accordance with the terms of Power Innovations standard warranty. Production processing does not necessarily include testing of all parameters.



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electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS				MIN	TYP	MAX	UNIT
Collector-emitter V _{(BR)CEO} breakdown voltage					BDW74	-45			
					BDW74A	-60			
	I _C = -30 mA	I _B = 0	(see Note 5)	BDW74B	-80			V	
				BDW74C	-100				
				BDW74D	-120				
Collector-emitter I _{CEO} cut-off current		V _{CE} = -30 V	I _B = 0		BDW74			-0.5	
	Colloctor omittor	$V_{CE} = -30 V$	$I_B = 0$		BDW74A			-0.5	
		$V_{CE} = -40 V$	$I_B = 0$		BDW74B			-0.5	mA
	V _{CE} = -50 V	$I_B = 0$		BDW74C			-0.5		
	V _{CE} = -60 V	$I_B = 0$		BDW74D			-0.5		
Collector cut-off I _{CBO} current	V _{CB} = -45 V	I _E = 0		BDW74			-0.2		
		V _{CB} = -60 V	$I_E = 0$		BDW74A			-0.2	
		V _{CB} = -80 V	$I_E = 0$		BDW74B			-0.2	
	V _{CB} = -100 V	$I_E = 0$		BDW74C			-0.2		
	V _{CB} = -120 V	$I_E = 0$		BDW74D			-0.2	A	
	current	V _{CB} = -45 V	$I_E = 0$	T _C = 150°C	BDW74			-5	mA
		V _{CB} = -60 V	$I_E = 0$	T _C = 150°C	BDW74A			-5	
		V _{CB} = -80 V	$I_E = 0$	T _C = 150°C	BDW74B			-5	
		V _{CB} = -100 V	$I_E = 0$	T _C = 150°C	BDW74C			-5	
		V _{CB} = -120 V	$I_E = 0$	T _C = 150°C	BDW74D			-5	
I _{EBO}	Emitter cut-off current	V _{EB} = -5 V	$I_{\rm C} = 0$	10 m	A ST CI			-2	mA
h	Forward current	$V_{CE} = -3 V$	I _C = -3 A	(see Notes 5 and		750		20000	
h _{FE}	transfer ratio	$V_{CE} = -3 V$	I _C = -8 A	(See Notes 5 and		100			
$V_{\text{BE(on)}}$	Base-emitter voltage	V _{CE} = -3 V	I _C = -3 A	(see Notes 5 and	16)			-2.5	V
V.	Collector-emitter	$I_{B} = -12 \text{ mA}$	I _C = -3 A	(see Notes 5 and	16)			-2.5	V
V _{CE(sat)}	saturation voltage	I _B = -80 mA	I _C = -8 A	(See Notes 5 and	. 0)			-4	v
V_{EC}	Parallel diode forward voltage	I _E = -8 A	Ι _Β = 0					-3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \ \mu$ s, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

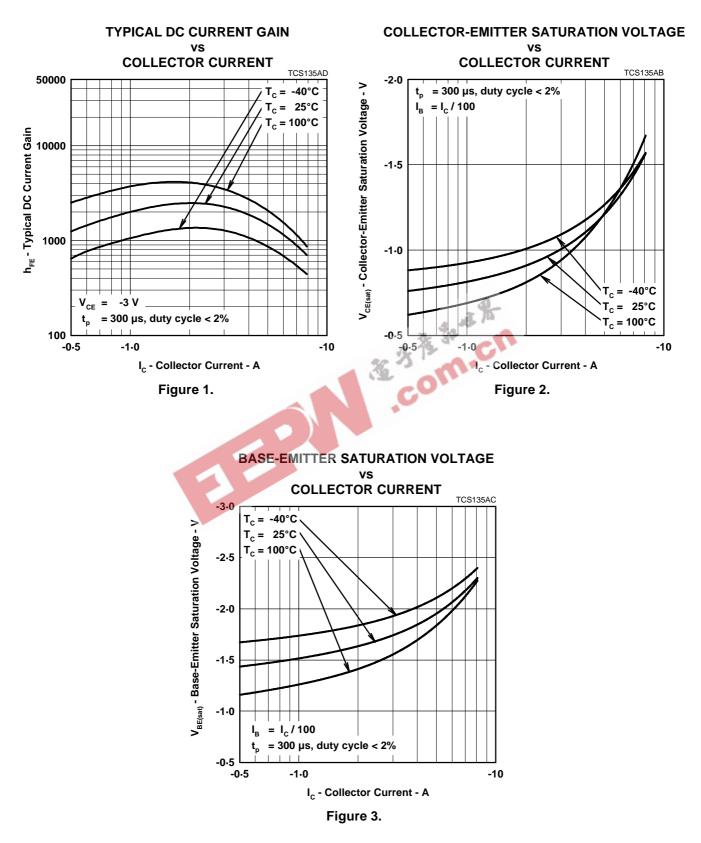
PARAMETER			ТҮР	MAX	UNIT
R _{θJC}	Junction to case thermal resistance			1.56	°C/W
R _{θJA}	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS [†]				TYP	MAX	UNIT
t _{on} Turn-on time	I _C = -3 A	I _{B(on)} = -12 mA	I _{B(off)} = 12 mA		1		μs
t _{off} Turn-off time	$V_{BE(off)} = 3.5 V$	R_{L} = 10 Ω	t_p = 20 μ s, dc \leq 2%		5		μs

[†] Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

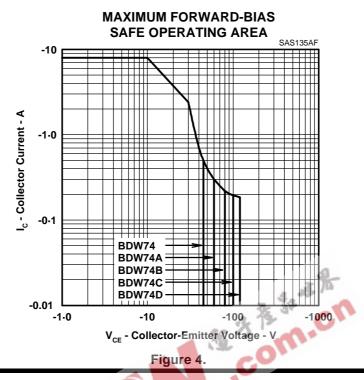
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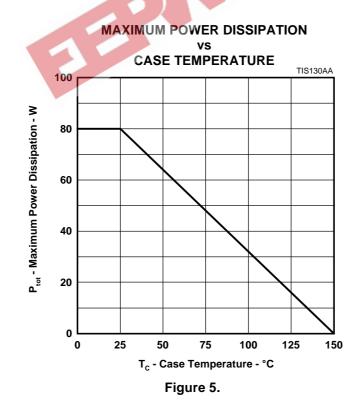
TYPICAL CHARACTERISTICS

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THERMAL INFORMATION



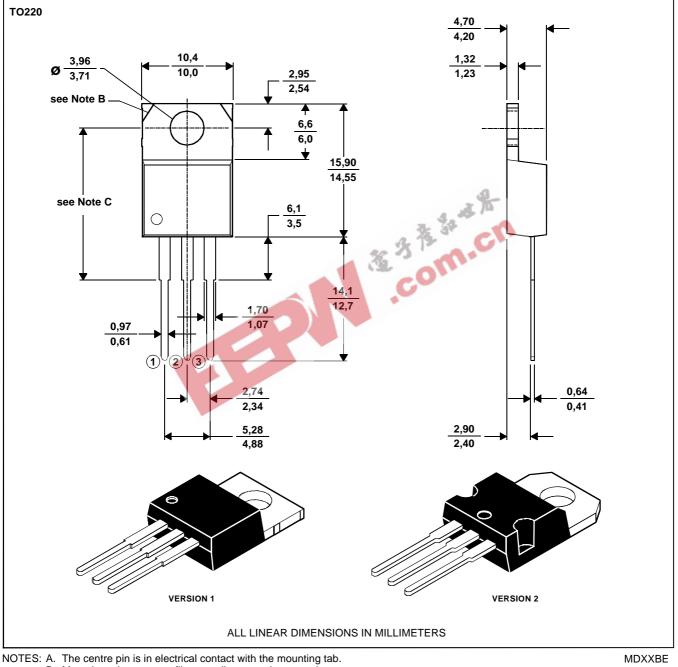
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MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



B. Mounting tab corner profile according to package version.

C. Typical fixing hole centre stand off height according to package version.

Version 1, 18.0 mm. Version 2, 17.6 mm.

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